COUNT	DESCRIPTION	ONS BY C		CHKD	HKD DATE		COUNT		DESCRIPTION OF REVISIONS		BY CHKD		DAT	DATE	
															
APPLICABLE STANDARD															
	VOLTAG	/OLTAGE		250 V AC					PERATING MPERATURE RANGE ORAGE -30 °C TO +85 °C(N				OTE	:1)	
RATING	CURREN			3A				TEMPERATURE RANGE			- 	-10 °C TO +60 °C(NOTE2)			
CABLE		UL1061,UL1007:AWG24					~28	B Cor	CONNECTOR DF3A-*P-2DSA					\(* *	k)
					SF	PECIFIC	CA	TIO	NS	3					
IT	EM	TEST METHOD								REQUIREMENTS					AT
CONSTR	UCTION											•			
GENERAL E	VISUALLY AND BY MEASURING INSTRUMENT. ACCORDING TO DRAWING.										×	×			
MARKING		CONFIRMED VISUALLY.													×
ELECTRIC CHARACTERISTICS															
CONTACT R	The state of the s								30 mΩ MAX.						
INSULATION RESISTANCE		500V DC							10	1000 MΩ MIN				×	_
VOLTAGE P	650V AC FOR 1 min							N	NO RLASHOVER OR BREAKDOWN					-	
MECHAN	ICAL CHA	RACTE	RIST	ics						-				·····	,
MECHANICA OPERATION	30TIMES INSERTIONS AND EXTRACTIONS.							- 1	 CONTACT RESISTANCE: 30 mΩ MAX. NO DAMAGE, CRACK AND LOSENESS OF PARTS. 					_	
VIBRATION	N .	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.							 NO ELECTRICAL DISCONTINUITY OF 1 μs. NO DAMAGE, CRACK AND LOSENESS 				×	_	
									OF PARTS.				-		
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.								① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK AND LOSENESS				×	_
								ľ	OF PARTS.						
ENVIRO	MENTAL	CHARA	CTE	RIS	ΓICS								·		
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C, 90 ∼ 95 %, 96 h.							- 1	① CONTACT RESISTANCE: $30 \text{ m}\Omega$ MAX. ② INSULATION RESISTANCE: $1000\text{M}\Omega$					
										MIN. NO DAMAGE, CRACK AND LOSENESS					_
RAPID CHA	TEMPERATURE _55 →5 TO 35 →+85 →5 TO 35 °C								OF PARTS. CONTACT RESISTANCE: 30 mQ MAX.						
TEMPERATURE										② INSULATION RESISTANCE:1000M Ω .					
		UNDER 5 CYCLES.								③ NO DAMAGE, CRACK AND LOSENESS OF PARTS.					
RESISTANC	SOLDER TEMPERATURE, 260±5°C FOR							-	NO DEFORMATION OF CASE OF						
SOLDERING	IMMERSION, DURATION, 5S.							İ	EXCESSIVE LOOSENESS OF THE						
SOLDERAB	SOLDERED AT SOLDER TEMPERATURE, 230±5°C FOR IMMERSION DURATION, 3S.								TERMINALS. A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95% OF THE SURFACE BEING IMMERSED.						
OOLDLIVID															
REMARKS	I -						DRAW		DESIGNED CHECKED APPROVE				RELEA	SED	
,			MPERATURE RISE BY CURRENT.					DRAWN DESIG		BEOIGIVED	OHLONED	,			.0
NOTE2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD,															
	D,OPERATING TEMPERATURE AND						M Niekomoto		2171 Sans	Things!	~/	ე .			
HUM	IS APPLIED FOR INTERIM TRANSPORTATION.					//	IVI. Nakamoto		H-Umehara Thyazaki J. Oma. 2 04.03.22 04.03.22 04.03.22		ma				
Unless otherwise specified, ref								4.09.	22	14 04.01.21 04.03,22 04.03.22					
	· · · · · ·						 st								
HRS	Note QT:Qualification Test AT:Assurance Test X:Applicable Test HIROSE ELECTRIC CO., LTD. SPECIFICATION SHEET PART NO. DF3-*S-2DSA (25)														
CODE NO (C)										r NO.	DF3-*	2-ZN	OA (25)	Ta /
CODE NO.(OL				ELC4-162329-10						CL543- 1 1					

TO